Inductors (Coils) > Chip Inductor (Chip Coil) > Power Inductor (Multilayer Type)

Data Sheet

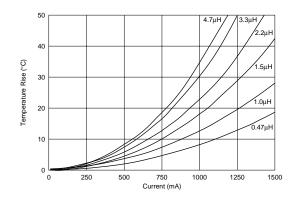
Chip Inductor (Chip Coil) Power Inductor (Multilayer Type) LQM31P_00 Series (1206 Size) Dimensions Packaging Code Packaging Minimum Quantity L 180mm Embossed Tape 3000 0.6±0.2 В Bulk(Bag) 1000 85±0. ` 1.6±0.2 3.2±0.2 (in mm) ■ Rated Value (□: packaging code) Part Number Inductance **Rated Current DC** Resistance Self Resonance Frequency (min.) LQM31PNR47M00 0.47µH±20% 1400mA 0.07ohm±25% 80MHz LQM31PN1R0M00 1.0µH±20% 1200mA 0.12ohm±25% 60MHz LQM31PN1R5M00 1.5µH±20% 1000mA 0.14ohm±25% 50MHz LQM31PN2R2M00 2.2µH±20% 900mA 0.19ohm±25% 40MHz LQM31PN3R3M00 3.3µH±20% 800mA 0.24ohm±25% 30MHz LQM31PN4R7M00 4.7µH±20% 700mA 0.30ohm±25% 25MHz Test Frequency: 1MHz Class of Magnetic Shield: Magnetic shield of ferrite Operating Temperature Range: -55°C to +125°C Inductance-Frequency Characteristics (Typ.) Inductance-Current Characteristics (Typ.) П 3.3uH Inductance (µH) Inductance (µH) 2.2µH ↓ 1.5ul ≤ 1.0uł - 0 47uF 0.1 └ 0.1 0.1 └─ 10 10 100 100 1000 10000 Frequency (MHz) Current (mA) Continued on the following page. This data sheet is applied for CHIP INDUCTORS (CHIP COILS) used for General Electronics equipment for your design. A Note: 1. This datasheet is downloaded from the website of Murata Manufacturing co., Itd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



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■ Temperature Rise Characteristics (Typ.)



■ ①Caution/Notice

Do not use products beyond the rated current as this may create excessive heat.

Notice

Data Sheet

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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